

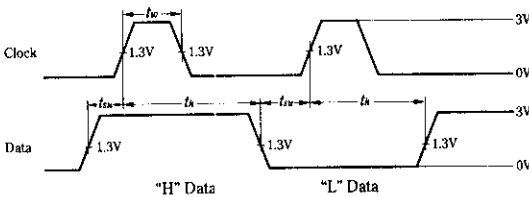
# HD74LS74A • Dual D-type Positive Edge-triggered Flip-Flops (with Preset and Clear)

## FUNCTION TABLE

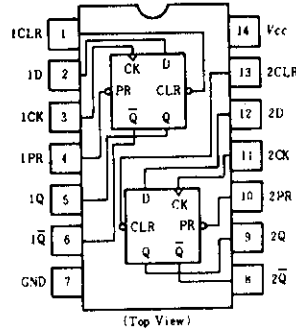
Inputs				Outputs	
Preset	Clear	Clock	D	Q	$\bar{Q}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H*	H*
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	L	X	$Q_0$	$\bar{Q}_0$

Notes) H; high level, L; low level, X; irrelevant  
 ↑; transition from low to high level  
 $Q_0$ ; level of Q before the indicated steady-state conditions were established.  
 $\bar{Q}_0$ ; complement of  $Q_0$  or level of  $\bar{Q}$  before the indicated steady-state input conditions were established.  
 \*: This configuration is nonstable, that is, it will not persist when preset and clear inputs return to their inactive (high) level.

## TIMING DEFINITION



## PIN ARRANGEMENT



## RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
Clock frequency	$f_{clock}$	0	—	25	MHz
Pulse width	Clock High	25	—	—	ns
	Clear/Preset	25	—	—	
Setup time	"H" Data	20↑	—	—	ns
	"L" Data	20↑	—	—	
Hold time	$t_h$	5↑	—	—	ns

Note) ↑; The arrow indicates the rising edge.

## ELECTRICAL CHARACTERISTICS ( $T_a = -20 \sim +75^\circ\text{C}$ )

Item	Symbol	Test Conditions	min	typ*	max	Unit		
Input voltage	$V_{IH}$		2.0	—	—	V		
	$V_{IL}$		—	—	0.8	V		
	$V_{OH}$	$V_{CC} = 4.75\text{V}, V_{IH} = 2\text{V}, V_{IL} = 0.8\text{V}, I_{OH} = -400\mu\text{A}$	2.7	—	—	V		
Output voltage	$V_{OL}$	$V_{CC} = 4.75\text{V}, V_{IL} = 0.8\text{V}, V_{IH} = 2\text{V}$	—	—	0.5	V		
		$I_{OL} = 8\text{mA}$ $I_{OL} = 4\text{mA}$	—	—	0.4			
Input current	D	$I_{IH}$	$V_{CC} = 5.25\text{V}, V_I = 2.7\text{V}$	—	—	20	$\mu\text{A}$	
				Clear	—	—		40
				Preset	—	—		40
				Clock	—	—		20
	D	$I_{IL}$	$V_{CC} = 5.25\text{V}, V_I = 0.4\text{V}$	—	—	-0.4	mA	
				Clear	—	—		-0.8
				Preset	—	—		-0.8
				Clock	—	—		-0.4
	D	$I_I$	$V_{CC} = 5.25\text{V}, V_I = 7\text{V}$	—	—	0.1	mA	
				Clear	—	—		0.2
				Preset	—	—		0.2
				Clock	—	—		0.1
Short-circuit output current	$I_{OS}$	$V_{CC} = 5.25\text{V}$	-20	—	-100	mA		
Supply current	$I_{CC}^{**}$	$V_{CC} = 5.25\text{V}$	—	4	8	mA		
Input clamp voltage	$V_{IK}$	$V_{CC} = 4.75\text{V}, I_{IN} = -18\text{mA}$	—	—	-1.5	V		

\*  $V_{CC} = 5\text{V}, T_a = 25^\circ\text{C}$

\*\* With all outputs open,  $I_{CC}$  is measured with the Q and  $\bar{Q}$  outputs high in turn. At the time of measurement, the clock input is grounded.

# HD74LS74A

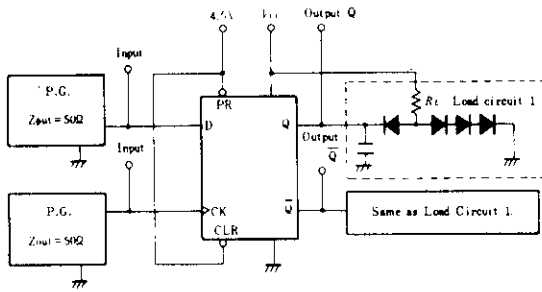
## SWITCHING CHARACTERISTICS (V<sub>CC</sub>=5V, T<sub>a</sub>=25°C)

Item	Symbol	Inputs	Outputs	Test Condition	min	typ	max	Unit
Maximum clock frequency	f <sub>max</sub>			C <sub>L</sub> =15pF, R <sub>L</sub> =2kΩ	25	33	-	MHz
Propagation delay time	t <sub>PLH</sub>	Clock, Clear	Q, $\bar{Q}$		-	13	25	ns
	t <sub>PHL</sub>	or Preset		-	25	40	ns	

## TESTING METHOD

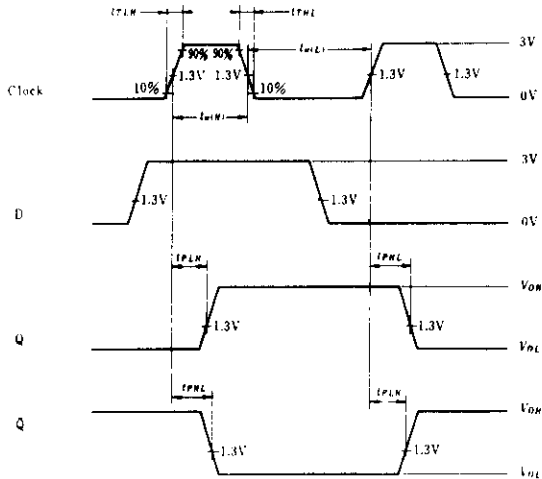
### 1) Test Circuit

1.1) f<sub>max</sub>, t<sub>PLH</sub>, t<sub>PHL</sub> (Clock→Q,  $\bar{Q}$ )



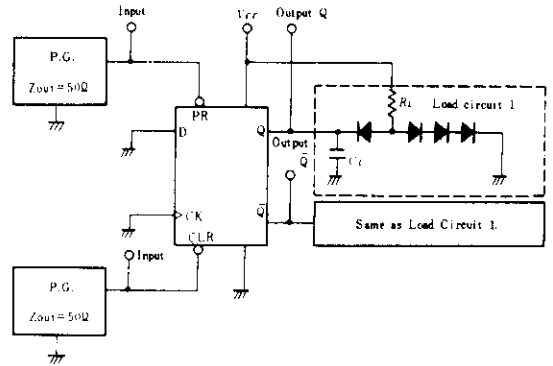
- Notes) 1. Test is put into the each flip-flop  
 2. All diodes are 1S2074 (⊕).  
 3. C<sub>L</sub> includes probe and jig capacitance.

### Waveform



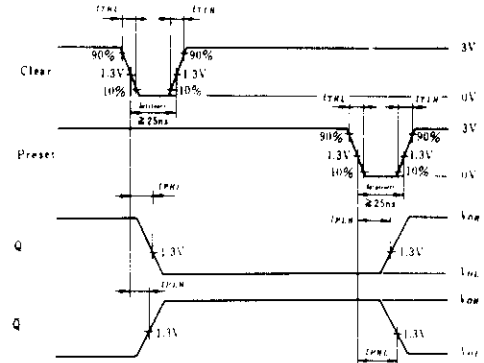
Note) Clock input pulse; t<sub>TLH</sub> ≤ 15ns,  
 t<sub>THL</sub> ≤ 6ns, PRR=1MHz, duty  
 cycle=50% and; for f<sub>max</sub>,  
 t<sub>TLH</sub> = t<sub>THL</sub> ≤ 2.5ns.

1.2) t<sub>PHL</sub>, t<sub>PLH</sub> (Clear or Preset→Q,  $\bar{Q}$ )



- Notes) 1. Test is put into the each flip-flop  
 2. All diodes are 1S2074 (⊕).  
 3. C<sub>L</sub> includes probe and jig capacitance.

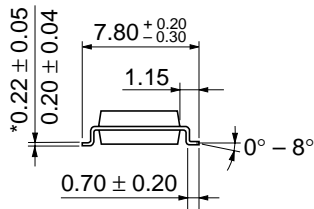
### Waveform



Note) Clear and preset input pulse;  
 t<sub>TLH</sub> ≤ 15ns, t<sub>THL</sub> ≤ 6ns,  
 PRR=1MHz

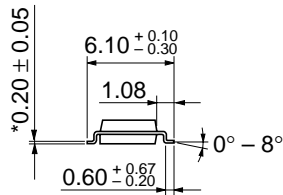
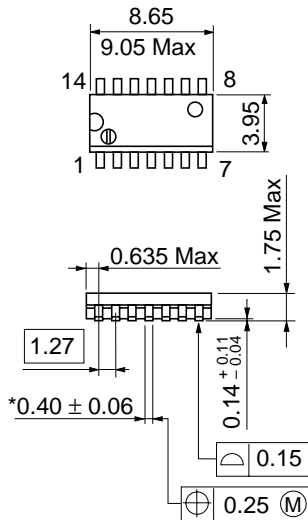


Hitachi Code	DP-14
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.97 g



Hitachi Code	FP-14DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.23 g

\*Dimension including the plating thickness  
Base material dimension



Hitachi Code	FP-14DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.13 g

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